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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

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Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I ² C, IrDA, LINbus, Microwire, SmartCard, SPI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, CapSense, LCD, LVD, POR, PWM, WDT
Number of I/O	19
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.71V ~ 5.5V
Data Converters	A/D 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	24-UFQFN Exposed Pad
Supplier Device Package	24-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c4045lqi-s411t

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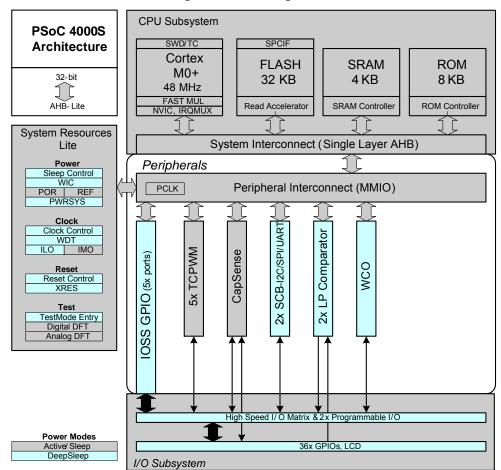


Figure 1. Block Diagram

PSoC 4000S devices include extensive support for programming, testing, debugging, and tracing both hardware and firmware.

The ARM Serial-Wire Debug (SWD) interface supports all programming and debug features of the device.

Complete debug-on-chip functionality enables full-device debugging in the final system using the standard production device. It does not require special interfaces, debugging pods, simulators, or emulators. Only the standard programming connections are required to fully support debug.

The PSoC Creator IDE provides fully integrated programming and debug support for the PSoC 4000S devices. The SWD interface is fully compatible with industry-standard third-party tools. The PSoC 4000S family provides a level of security not possible with multi-chip application solutions or with microcontrollers. It has the following advantages:

- Allows disabling of debug features
- Robust flash protection
- Allows customer-proprietary functionality to be implemented in on-chip programmable blocks

The debug circuits are enabled by default and can be disabled in firmware. If they are not enabled, the only way to re-enable them is to erase the entire device, clear flash protection, and reprogram the device with new firmware that enables debugging. Thus firmware control of debugging cannot be over-ridden without erasing the firmware thus providing security.

Additionally, all device interfaces can be permanently disabled (device security) for applications concerned about phishing attacks due to a maliciously reprogrammed device or attempts to defeat security by starting and interrupting flash programming sequences. All programming, debug, and test interfaces are disabled when maximum device security is enabled. Therefore, PSoC 4000S, with device security enabled, may not be returned for failure analysis. This is a trade-off the PSoC 4000S allows the customer to make.



Functional Definition

CPU and Memory Subsystem

CPU

The Cortex-M0+ CPU in the PSoC 4000S is part of the 32-bit MCU subsystem, which is optimized for low-power operation with extensive clock gating. Most instructions are 16 bits in length and the CPU executes a subset of the Thumb-2 instruction set. It includes a nested vectored interrupt controller (NVIC) block with eight interrupt inputs and also includes a Wakeup Interrupt Controller (WIC). The WIC can wake the processor from Deep Sleep mode, allowing power to be switched off to the main processor when the chip is in Deep Sleep mode.

The CPU also includes a debug interface, the serial wire debug (SWD) interface, which is a two-wire form of JTAG. The debug configuration used for PSoC 4000S has four breakpoint (address) comparators and two watchpoint (data) comparators.

Flash

The PSoC 4000S device has a flash module with a flash accelerator, tightly coupled to the CPU to improve average access times from the flash block. The low-power flash block is designed to deliver two wait-state (WS) access time at 48 MHz. The flash accelerator delivers 85% of single-cycle SRAM access performance on average.

SRAM

Four KB of SRAM are provided with zero wait-state access at 48 MHz.

SROM

A supervisory ROM that contains boot and configuration routines is provided.

System Resources

Power System

The power system is described in detail in the section Power on page 10. It provides assurance that voltage levels are as required for each respective mode and either delays mode entry (for example, on power-on reset (POR)) until voltage levels are as required for proper functionality, or generates resets (for example, on brown-out detection). The PSoC 4000S operates with a single external supply over the range of either 1.8 V \pm 5% (externally regulated) or 1.8 to 5.5 V (internally regulated) and has three different power modes, transitions between which are managed by the power system. The PSoC 4000S provides Active, Sleep, and Deep Sleep low-power modes.

All subsystems are operational in Active mode. The CPU subsystem (CPU, flash, and SRAM) is clock-gated off in Sleep mode, while all peripherals and interrupts are active with instantaneous wake-up on a wake-up event. In Deep Sleep mode, the high-speed clock and associated circuitry is switched off; wake-up from this mode takes 35 µs. The opamps can remain operational in Deep Sleep mode.

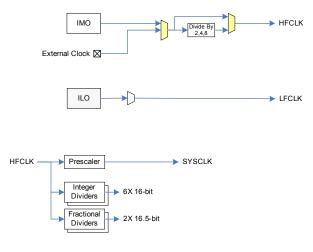
Clock System

The PSoC 4000S clock system is responsible for providing clocks to all subsystems that require clocks and for switching between different clock sources without glitching. In addition, the clock system ensures that there are no metastable conditions.

The clock system for the PSoC 4000S consists of the internal main oscillator (IMO), internal low-frequency oscillator (ILO), a 32 kHz Watch Crystal Oscillator (WCO) and provision for an external clock. Clock dividers are provided to generate clocks for peripherals on a fine-grained basis. Fractional dividers are also provided to enable clocking of higher data rates for UARTs.

The HFCLK signal can be divided down to generate synchronous clocks for the analog and digital peripherals. There are eight clock dividers for the PSoC 4000S, two of those are fractional dividers. The 16-bit capability allows flexible generation of fine-grained frequency values, and is fully supported in PSoC Creator.

Figure 2. PSoC 4000S MCU Clocking Architecture



IMO Clock Source

The IMO is the primary source of internal clocking in the PSoC 4000S. It is trimmed during testing to achieve the specified accuracy. The IMO default frequency is 24 MHz and it can be adjusted from 24 to 48 MHz in steps of 4 MHz. The IMO tolerance with Cypress-provided calibration settings is ±2%.

ILO Clock Source

The ILO is a very low power, nominally 40-kHz oscillator, which is primarily used to generate clocks for the watchdog timer (WDT) and peripheral operation in Deep Sleep mode. ILO-driven counters can be calibrated to the IMO to improve accuracy. Cypress provides a software component, which does the calibration.

Watch Crystal Oscillator (WCO)

The PSoC 4000S clock subsystem also implements a low-frequency (32-kHz watch crystal) oscillator that can be used for precision timing applications.



GPIO

The PSoC 4000S has up to 36 GPIOs. The GPIO block implements the following:

- Eight drive modes:
 - □ Analog input mode (input and output buffers disabled)
 - □ Input only
 - □ Weak pull-up with strong pull-down
 - □ Strong pull-up with weak pull-down
 - □ Open drain with strong pull-down
 - Open drain with strong pull-up
 - □ Strong pull-up with strong pull-down
 - Weak pull-up with weak pull-down
- Input threshold select (CMOS or LVTTL).
- Individual control of input and output buffer enabling/disabling in addition to the drive strength modes
- Selectable slew rates for dV/dt related noise control to improve EMI

The pins are organized in logical entities called ports, which are 8-bit in width (less for Ports 2 and 3). During power-on and reset, the blocks are forced to the disable state so as not to crowbar any inputs and/or cause excess turn-on current. A multiplexing network known as a high-speed I/O matrix is used to multiplex between various signals that may connect to an I/O pin.

Data output and pin state registers store, respectively, the values to be driven on the pins and the states of the pins themselves.

Every I/O pin can generate an interrupt if so enabled and each I/O port has an interrupt request (IRQ) and interrupt service routine (ISR) vector associated with it (5 for PSoC 4000S).

Special Function Peripherals

CapSense

CapSense is supported in the PSoC 4000S through a CapSense Sigma-Delta (CSD) block that can be connected to any pins through an analog multiplex bus via analog switches. CapSense function can thus be provided on any available pin or group of pins in a system under software control. A PSoC Creator component is provided for the CapSense block to make it easy for the user. Shield voltage can be driven on another analog multiplex bus to provide water-tolerance capability. Water tolerance is provided by driving the shield electrode in phase with the sense electrode to keep the shield capacitance from attenuating the sensed input. Proximity sensing can also be implemented.

The CapSense block has two IDACs, which can be used for general purposes if CapSense is not being used (both IDACs are available in that case) or if CapSense is used without water tolerance (one IDAC is available).

The CapSense block also provides a 10-bit Slope ADC function, which can be used in conjunction with the CapSense function.

The CapSense block is an advanced, low-noise, programmable block with programmable voltage references and current source ranges for improved sensitivity and flexibility. It can also use an external reference voltage. It has a full-wave CSD mode that alternates sensing to VDDA and Ground to null out power-supply related noise.

LCD Segment Drive

The PSoC 4000S has an LCD controller, which can drive up to 8 commons and up to 28 segments. It uses full digital methods to drive the LCD segments requiring no generation of internal LCD voltages. The two methods used are referred to as Digital Correlation and PWM. Digital Correlation pertains to modulating the frequency and drive levels of the common and segment signals to generate the highest RMS voltage across a segment to light it up or to keep the RMS signal to zero. This method is good for STN displays but may result in reduced contrast with TN (cheaper) displays. PWM pertains to driving the panel with PWM signals to effectively use the capacitance of the panel to provide the integration of the modulated pulse-width to generate the desired LCD voltage. This method results in higher power consumption but can result in better results when driving TN displays. LCD operation is supported during Deep Sleep refreshing a small display buffer (4 bits; 1 32-bit register per port).



Pinouts

The following table provides the pin list for PSoC 4000S for the 48-pin TQFP, 40-pin QFN, 32-pin QFN, 24-pin QFN, and 25-ball CSP packages. All port pins support GPIO. Pin 11 is a No-Connect in the 48-TQFP.

Table 1.	PSoC	4000S	Pin L	ist
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48	-TQFP	32	2-QFN	2	4-QFN	25-CSP		4	10-QFN
Pin	Name	Pin	Name	Pin	Name	Pin	Name	Pin	Name
28	P0.0	17	P0.0	13	P0.0	D1	P0.0	22	P0.0
29	P0.1	18	P0.1	14	P0.1	C3	P0.1	23	P0.1
30	P0.2	19	P0.2					24	P0.2
31	P0.3	20	P0.3					25	P0.3
32	P0.4	21	P0.4	15	P0.4	C2	P0.4	26	P0.4
33	P0.5	22	P0.5	16	P0.5	C1	P0.5	27	P0.5
34	P0.6	23	P0.6	17	P0.6	B1	P0.6	28	P0.6
35	P0.7					B2	P0.7	29	P0.7
36	XRES	24	XRES	18	XRES	B3	XRES	30	XRES
37	VCCD	25	VCCD	19	VCCD	A1	VCCD	31	VCCD
38	VSSD	26	VSSD	20	VSSD	A2	VSS		
39	VDDD	27	VDD	21	VDD	A3	VDD	32	VDDD
40	VDDA	27	VDD	21	VDD	A3	VDD	33	VDDA
41	VSSA	28	VSSA	22	VSSA	A2	VSS	34	VSSA
42	P1.0	29	P1.0					35	P1.0
43	P1.1	30	P1.1					36	P1.1
44	P1.2	31	P1.2	23	P1.2	A4	P1.2	37	P1.2
45	P1.3	32	P1.3	24	P1.3	B4	P1.3	38	P1.3
46	P1.4							39	P1.4
47	P1.5								
48	P1.6								
1	P1.7	1	P1.7	1	P1.7	A5	P1.7	40	P1.7
2	P2.0	2	P2.0	2	P2.0	B5	P2.0	1	P2.0
3	P2.1	3	P2.1	3	P2.1	C5	P2.1	2	P2.1
4	P2.2	4	P2.2					3	P2.2
5	P2.3	5	P2.3					4	P2.3
6	P2.4							5	P2.4
7	P2.5	6	P2.5					6	P2.5
8	P2.6	7	P2.6	4	P2.6	D5	P2.6	7	P2.6
9	P2.7	8	P2.7	5	P2.7	C4	P2.7	8	P2.7
10	VSSD					A2	VSS	9	VSSD
12	P3.0	9	P3.0	6	P3.0	E5	P3.0	10	P3.0
13	P3.1	10	P3.1			D4	P3.1	11	P3.1
14	P3.2	11	P3.2	7	P3.2	E4	P3.2	12	P3.2
16	P3.3	12	P3.3	8	P3.3	D3	P3.3	13	P3.3



Table 1. PSoC 4000S Pin List (continued)

48	-TQFP	32	2-QFN	24-QFN 25-CSP		24-QFN 25-CSP		25-CSP		40-QFN
Pin	Name	Pin	Name	Pin	Name	Pin	Name	Pin	Name	
17	P3.4							14	P3.4	
18	P3.5							15	P3.5	
19	P3.6							16	P3.6	
20	P3.7							17	P3.7	
21	VDDD									
22	P4.0	13	P4.0	9	P4.0	E3	P4.0	18	P4.0	
23	P4.1	14	P4.1	10	P4.1	D2	P4.1	19	P4.1	
24	P4.2	15	P4.2	11	P4.2	E2	P4.2	20	P4.2	
25	P4.3	16	P4.3	12	P4.3	E1	P4.3	21	P4.3	

Descriptions of the Pin functions are as follows:

VDDD: Power supply for the digital section.

VDDA: Power supply for the analog section.

VSSD, VSSA: Ground pins for the digital and analog sections respectively.

VCCD: Regulated digital supply (1.8 V ±5%)

VDD: Power supply to all sections of the chip

VSS: Ground for all sections of the chip

Alternate Pin Functions

Each port pin can be assigned to one of multiple functions; it can, for instance, be an analog I/O, a digital peripheral function, an LCD pin, or a CapSense pin. The pin assignments are shown in the following table.

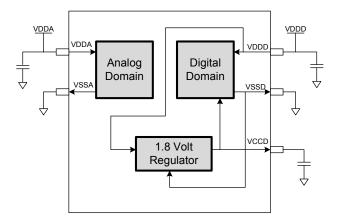
Port/ Pin	Analog	Smart I/O	Alternate Function 1	Alternate Function 2	Alternate Function 3	Deep Sleep 1	Deep Sleep 2
P0.0	lpcomp.in_p[0]				tcpwm.tr_in[0]		scb[0].spi_select1:0
P0.1	lpcomp.in_n[0]				tcpwm.tr_in[1]		scb[0].spi_select2:0
P0.2	lpcomp.in_p[1]						scb[0].spi_select3:0
P0.3	lpcomp.in_n[1]						
P0.4	wco.wco_in			scb[1].uart_rx:0		scb[1].i2c_scl:0	scb[1].spi_mosi:1
P0.5	wco.wco_out			scb[1].uart_tx:0		scb[1].i2c_sda:0	scb[1].spi_miso:1
P0.6			srss.ext_clk	scb[1].uart_cts:0			scb[1].spi_clk:1
P0.7				scb[1].uart_rts:0			scb[1].spi_select0:1
P1.0			tcpwm.line[2]:1	scb[0].uart_rx:1		scb[0].i2c_scl:0	scb[0].spi_mosi:1
P1.1			tcpwm.line_compl[2]:1	scb[0].uart_tx:1		scb[0].i2c_sda:0	scb[0].spi_miso:1
P1.2			tcpwm.line[3]:1	scb[0].uart_cts:1	tcpwm.tr_in[2]		scb[0].spi_clk:1
P1.3			tcpwm.line_compl[3]:1	scb[0].uart_rts:1	tcpwm.tr_in[3]		scb[0].spi_select0:1
P1.4							scb[0].spi_select1:1
P1.5							scb[0].spi_select2:1



Power

The following power system diagram shows the set of power supply pins as implemented for the PSoC 4000S. The system has one regulator in Active mode for the digital circuitry. There is no analog regulator; the analog circuits run directly from the V_{DD} input.

Figure 3. Power Supply Connections



There are two distinct modes of operation. In Mode 1, the supply voltage range is 1.8 V to 5.5 V (unregulated externally; internal regulator operational). In Mode 2, the supply range is $1.8 \text{ V} \pm 5\%$ (externally regulated; 1.71 to 1.89, internal regulator bypassed).

Mode 1: 1.8 V to 5.5 V External Supply

In this mode, the PSoC 4000S is powered by an external power supply that can be anywhere in the range of 1.8 to 5.5 V. This range is also designed for battery-powered operation. For example, the chip can be powered from a battery system that starts at 3.5 V and works down to 1.8 V. In this mode, the internal regulator of the PSoC 4000S supplies the internal logic and its output is connected to the V_{CCD} pin. The VCCD pin must be bypassed to ground via an external capacitor (0.1 μ F; X5R ceramic or better) and must not be connected to anything else.

Mode 2: 1.8 V ±5% External Supply

In this mode, the PSoC 4000S is powered by an external power supply that must be within the range of 1.71 to 1.89 V; note that this range needs to include the power supply ripple too. In this mode, the VDD and VCCD pins are shorted together and bypassed. The internal regulator can be disabled in the firmware.

Bypass capacitors must be used from VDDD to ground. The typical practice for systems in this frequency range is to use a capacitor in the 1- μ F range, in parallel with a smaller capacitor (0.1 μ F, for example). Note that these are simply rules of thumb and that, for critical applications, the PCB layout, lead inductance, and the bypass capacitor parasitic should be simulated to design and obtain optimal bypassing.

An example of a bypass scheme is shown in the following diagram.

Figure 4. External Supply Range from 1.8 V to 5.5 V with Internal Regulator Active

Power supply bypass connections example

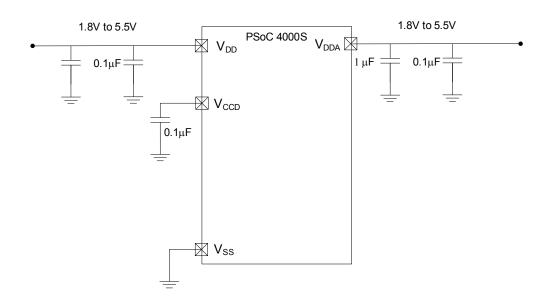




Table 3. DC Specifications (continued)

Typical values measured at V_DD = 3.3 V and 25 $^\circ\text{C}.$

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions				
Sleep Mode, V	Sleep Mode, V _{DDD} = 1.71 V to 1.89 V (Regulator bypassed)										
SID28	I _{DD23}	I ² C wakeup, WDT, and Comparators on	_	0.7	0.9	mA	6 MHz				
SID28A	I _{DD23A}	I ² C wakeup, WDT, and Comparators on	-	0.9	1.1	mA	12 MHz				
Deep Sleep Me	ode, V _{DD} = 1.8 V	to 3.6 V (Regulator on)					•				
SID31	I _{DD26}	I ² C wakeup and WDT on	-	2.5	60	μA	-				
Deep Sleep Me	ode, V _{DD} = 3.6 V	to 5.5 V (Regulator on)					•				
SID34	I _{DD29}	I ² C wakeup and WDT on	-	2.5	60	μA	-				
Deep Sleep Me	ode, V _{DD} = V _{CCD}	= 1.71 V to 1.89 V (Regulator bypasse	d)				•				
SID37	I _{DD32}	I ² C wakeup and WDT on	-	2.5	60	μA	-				
XRES Current	RES Current										
SID307	I _{DD_XR}	Supply current while XRES asserted	_	2	5	mA	_				

Table 4. AC Specifications

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions
SID48	F _{CPU}	CPU frequency	DC	-	48	MHz	$1.71 \leq V_{DD} \leq 5.5$
SID49 ^[3]	T _{SLEEP}	Wakeup from Sleep mode	-	0	-	110	
SID50 ^[3]	T _{DEEPSLEEP}	Wakeup from Deep Sleep mode	-	35	-	μs	



Analog Peripherals

Table 9. Comparator DC Specifications

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/ Conditions
SID84	V _{OFFSET1}	Input offset voltage, Factory trim	-	-	±10		-
SID85	V _{OFFSET2}	Input offset voltage, Custom trim	-	-	±4	mV	-
SID86	V _{HYST}	Hysteresis when enabled	-	10	35		-
SID87	V _{ICM1}	Input common mode voltage in normal mode	0	-	V _{DDD} -0.1		Modes 1 and 2
SID247	V _{ICM2}	Input common mode voltage in low power mode	0	-	V _{DDD}	V	-
SID247A	V _{ICM3}	Input common mode voltage in ultra low power mode	0	-	V _{DDD} -1.15		V _{DDD} ≥ 2.2 V at _40 °C
SID88	C _{MRR}	Common mode rejection ratio	50	-	_	dB	V _{DDD} ≥ 2.7V
SID88A	C _{MRR}	Common mode rejection ratio	42	-	-	uБ	$V_{DDD} \le 2.7V$
SID89	I _{CMP1}	Block current, normal mode	-	-	400		-
SID248	I _{CMP2}	Block current, low power mode	-	-	100	μA	-
SID259	I _{CMP3}	Block current in ultra low-power mode	-	6	28	- Fr. (V _{DDD} ≥ 2.2 V at _40 °C
SID90	Z _{CMP}	DC Input impedance of comparator	35	-	-	MΩ	-

Table 10. Comparator AC Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/ Conditions
SID91	TRESP1	Response time, normal mode, 50 mV overdrive	-	38	110	ns	_
SID258	TRESP2	Response time, low power mode, 50 mV overdrive	-	70	200	115	_
SID92	TRESP3	Response time, ultra-low power mode, 200 mV overdrive	-	2.3	15	μs	V _{DDD} ≥ 2.2 V at _40 °C



CSD

Table 11. CSD and IDAC Specifications

SPEC ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SYS.PER#3	VDD_RIPPLE	Max allowed ripple on power supply, DC to 10 MHz	-	-	±50	mV	V _{DD} > 2 V (with ripple), 25 °C T _A , Sensitivity = 0.1 pF
SYS.PER#16	VDD_RIPPLE_1.8	Max allowed ripple on power supply, DC to 10 MHz	-	_	±25	mV	V_{DD} > 1.75V (with ripple), 25 °C T _A , Parasitic Capaci- tance (C _P) < 20 pF, Sensitivity ≥ 0.4 pF
SID.CSD.BLK	ICSD	Maximum block current	-	_	4000	μA	Maximum block current for both IDACs in dynamic (switching) mode including comparators, buffer, and reference generator.
SID.CSD#15	V _{REF}	Voltage reference for CSD and Comparator	0.6	1.2	V _{DDA} - 0.6	V	V _{DDA} - 0.06 or 4.4, whichever is lower
SID.CSD#15A	VREF_EXT	External Voltage reference for CSD and Comparator	0.6		V _{DDA} - 0.6	V	V _{DDA} - 0.06 or 4.4, whichever is lower
SID.CSD#16	IDAC1IDD	IDAC1 (7-bits) block current	-	-	1750	μA	
SID.CSD#17	IDAC2IDD	IDAC2 (7-bits) block current	-	-	1750	μA	
SID308	VCSD	Voltage range of operation	1.71	-	5.5	V	1.8 V ±5% or 1.8 V to 5.5 V
SID308A	VCOMPIDAC	Voltage compliance range of IDAC	0.6	-	V _{DDA} –0.6	V	V _{DDA} - 0.06 or 4.4, whichever is lower
SID309	IDAC1DNL	DNL	-1	-	1	LSB	
SID310	IDAC1INL	INL	-2	-	2	LSB	INL is ±5.5 LSB for V _{DDA} < 2 V
SID311	IDAC2DNL	DNL	DNL –1 –				
SID312	IDAC2INL	INL	-2 - 2 L		LSB	INL is ±5.5 LSB for V _{DDA} < 2 V	
SID313	SNR	Ratio of counts of finger to noise. Guaranteed by characterization	5	-	-	Ratio	Capacitance range of 5 to 35 pF, 0.1-pF sensitivity. All use cases. V _{DDA} > 2 V.
SID314	IDAC1CRT1	Output current of IDAC1 (7 bits) in low range	4.2	-	5.4	μA	LSB = 37.5-nA typ.
SID314A	IDAC1CRT2	Output current of IDAC1(7 bits) in medium range	34	-	41	μA	LSB = 300-nA typ.
SID314B	IDAC1CRT3	Output current of IDAC1(7 bits) in high range	275	-	330	μA	LSB = 2.4-µA typ.
SID314C	IDAC1CRT12	Output current of IDAC1 (7 bits) in low range, 2X mode	8	-	10.5	μA	LSB = 75-nA typ.
SID314D	IDAC1CRT22	Output current of IDAC1(7 bits) in medium range, 2X mode	69	-	82	μA	LSB = 600-nA typ.
SID314E	IDAC1CRT32	Output current of IDAC1(7 bits) in high range, 2X mode	540	-	660	μA	LSB = 4.8-µA typ.
SID315	IDAC2CRT1	Output current of IDAC2 (7 bits) in low range	. ,		5.4	μA	LSB = 37.5-nA typ.
SID315A	IDAC2CRT2	Output current of IDAC2 (7 bits) in medium range	34	-	41	μA	LSB = 300-nA typ.
SID315B	IDAC2CRT3	Output current of IDAC2 (7 bits) in high range	275	-	330	μA	LSB = 2.4-µA typ.
SID315C	IDAC2CRT12	Output current of IDAC2 (7 bits) in low range, 2X mode	8	-	10.5	μA	LSB = 75-nA typ.
SID315D	IDAC2CRT22	Output current of IDAC2(7 bits) in medium range, 2X mode	69	-	82	μA	LSB = 600-nA typ.
SID315E	IDAC2CRT32	Output current of IDAC2(7 bits) in high range, 2X mode	540	-	660	μA	LSB = 4.8-µA typ.
SID315F	IDAC3CRT13	Output current of IDAC in 8-bit mode in low range	8	-	10.5	μA	LSB = 37.5-nA typ.



Table 11. CSD and IDAC Specifications (continued)

SPEC ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SID315G	IDAC3CRT23	Output current of IDAC in 8-bit mode in medium range	69	-	82	μA	LSB = 300-nA typ.
SID315H	IDAC3CRT33	Output current of IDAC in 8-bit mode in high range	540	-	660	μA	LSB = 2.4-µA typ.
SID320	IDACOFFSET	All zeroes input	-	-	1	LSB	Polarity set by Source or Sink. Offset is 2 LSBs for 37.5 nA/LSB mode
SID321	IDACGAIN	Full-scale error less offset	-	-	±10	%	
SID322	IDACMISMATCH1	Mismatch between IDAC1 and IDAC2 in Low mode	-	-	9.2	LSB	LSB = 37.5-nA typ.
SID322A	IDACMISMATCH2	Mismatch between IDAC1 and IDAC2 in Medium mode	-	-	5.6	LSB	LSB = 300-nA typ.
SID322B	IDACMISMATCH3	Mismatch between IDAC1 and IDAC2 in High mode	-	-	6.8	LSB	LSB = 2.4-µA typ.
SID323	IDACSET8	Settling time to 0.5 LSB for 8-bit IDAC	-	-	10	μs	Full-scale transition. No external load.
SID324	IDACSET7	Settling time to 0.5 LSB for 7-bit IDAC	-	-	10	μs	Full-scale transition. No external load.
SID325	CMOD	External modulator capacitor.	-	2.2	-	nF	5-V rating, X7R or NP0 cap.

Table 12. 10-bit CapSense ADC Specifications

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SIDA94	A_RES	Resolution	_	-	10	bits	Auto-zeroing is required every millisecond
SIDA95	A_CHNLS_S	Number of channels - single ended	-	_	16		Defined by AMUX Bus.
SIDA97	A-MONO	Monotonicity	-	-	-	Yes	
SIDA98	A_GAINERR	Gain error	_	-	±2	%	In V_{REF} (2.4 V) mode with V_{DDA} bypass capacitance of 10 μ F
SIDA99	A_OFFSET	Input offset voltage	_	-	3	mV	In V_{REF} (2.4 V) mode with V_{DDA} bypass capacitance of 10 μ F
SIDA100	A_ISAR	Current consumption	-	-	0.25	mA	
SIDA101	A_VINS	Input voltage range - single ended	V_{SSA}	-	V _{DDA}	V	
SIDA103	A_INRES	Input resistance	-	2.2	-	KΩ	
SIDA104	A_INCAP	Input capacitance	-	20	-	pF	
SIDA106	A_PSRR	Power supply rejection ratio	_	60	_	dB	In V_{REF} (2.4 V) mode with V_{DDA} bypass capacitance of 10 μ F
SIDA107	A_TACQ	Sample acquisition time	-	1	-	μs	
SIDA108	A_CONV8	Conversion time for 8-bit resolution at conversion rate = Fhclk/(2^(N+2)). Clock frequency = 48 MHz.	-	_	21.3	μs	Does not include acqui- sition time. Equivalent to 44.8 ksps including acquisition time.
SIDA108A	A_CONV10	Conversion time for 10-bit resolution at conversion rate = Fhclk/(2^(N+2)). Clock frequency = 48 MHz.	-	_	85.3	μs	Does not include acqui- sition time. Equivalent to 11.6 ksps including acquisition time.



Table 12. 10-bit CapSense ADC Specifications (continued)

Spec ID#	Parameter	Description	Min	Тур	Мах	Units	Details/Conditions
SIDA109	A_SND	Signal-to-noise and Distortion ratio (SINAD)	-	61	_	dB	With 10-Hz input sine wave, external 2.4-V reference, V _{REF} (2.4 V) mode
SIDA110	A_BW	Input bandwidth without aliasing	-	-	22.4	kHz	8-bit resolution
SIDA111	A_INL	Integral Non Linearity. 1 ksps	-	-	2	LSB	V _{REF} = 2.4 V or greater
SIDA112	A_DNL	Differential Non Linearity. 1 ksps	-	-	1	LSB	

Digital Peripherals

Timer Counter Pulse-Width Modulator (TCPWM)

Table 13. TCPWM Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID.TCPWM.1	ITCPWM1	Block current consumption at 3 MHz	-	-	- 45		All modes (TCPWM)
SID.TCPWM.2	ITCPWM2	Block current consumption at 12 MHz	-	-	155	μA	All modes (TCPWM)
SID.TCPWM.2A	ITCPWM3	Block current consumption at 48 MHz	-	-	650		All modes (TCPWM)
SID.TCPWM.3	TCPWM _{FREQ}	Operating frequency	_	_	Fc	MHz	Fc max = CLK_SYS Maximum = 48 MHz
SID.TCPWM.4	TPWM _{ENEXT}	Input trigger pulse width	2/Fc	-	_		For all trigger events ^[6]
SID.TCPWM.5	TPWM _{EXT}	Output trigger pulse widths	2/Fc	_	_		Minimum possible width of Overflow, Underflow, and CC (Counter equals Compare value) outputs
SID.TCPWM.5A	TC _{RES}	Resolution of counter	1/Fc	_	_	ns	Minimum time between successive counts
SID.TCPWM.5B	PWM _{RES}	PWM resolution	1/Fc	_	_		Minimum pulse width of PWM Output
SID.TCPWM.5C	Q _{RES}	Quadrature inputs resolution	1/Fc – –			Minimum pulse width between Quadrature phase inputs	



Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SID398	FWCO	Crystal Frequency	-	32.768	-	kHz	
SID399	FTOL	Frequency tolerance	-	50	250	ppm	With 20-ppm crystal
SID400	ESR	Equivalent series resistance	-	50	-	kΩ	
SID401	PD	Drive Level	-	-	1	μW	
SID402	TSTART	Startup time	-	-	500	ms	
SID403	CL	Crystal Load Capacitance	6	-	12.5	pF	
SID404	C0	Crystal Shunt Capacitance	-	1.35	-	pF	
SID405	IWCO1	Operating Current (high power mode)	-	-	8	uA	
SID406	IWCO2	Operating Current (low power mode)	-	-	1	uA	

Table 31. Watch Crystal Oscillator (WCO) Specifications

Table 32. External Clock Specifications

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
	1	External clock input frequency	0	-	48	MHz	-
SID306 ^[12]	ExtClkDuty	Duty cycle; measured at V _{DD/2}	45	-	55	%	-

Table 33. Block Specs

Spec ID	Parameter	Description	Min	Тур	Max	Units	Details/Conditions
SID262 ^[12]	T _{CLKSWITCH}	System clock source switching time	3	-	4	Periods	-

Table 34. Smart I/O Pass-through Time (Delay in Bypass Mode)

Spec ID#	Parameter	Description	Min	Тур	Max	Units	Details / Conditions
SID252	PRG_BYPASS	Max delay added by Smart I/O in bypass mode	-	-	1.6	ns	



Ordering Information

The PSoC 4000S part numbers and features are listed in the following table.

Table 35. PSoC 4000S Ordering Information

							Feat	ures							P	acka	je	
Category	MPN	Max CPU Speed (MHz)	Flash (KB)	SRAM (KB)	Opamp (CTBm)	CapSense	10-bit CSD ADC	12-bit SAR ADC	LP Comparators	TCPWM Blocks	SCB Blocks	Smart I/Os	GPIO	WLCSP (0.35-mm pitch)	24-Pin QFN	32-Pin QFN	40-Pin QFN	48-Pin TQFP
	CY8C4024FNI-S402	24	16	2	0	0	1	0	2	5	2	8	21	>				
	CY8C4024LQI-S401	24	16	2	0	0	1	0	2	5	2	8	19		~			
	CY8C4024LQI-S402	24	16	2	0	0	1	0	2	5	2	16	27			~		
	CY8C4024LQI-S403	24	16	2	0	0	1	0	2	5	2	16	34				~	
4024	CY8C4024AZI-S403	24	16	2	0	0	1	0	2	5	2	16	36					~
	CY8C4024FNI-S412	24	16	2	0	1	1	0	2	5	2	8	21	~				
	CY8C4024LQI-S411	24	16	2	0	1	1	0	2	5	2	8	19		~			
	CY8C4024LQI-S412	24	16	2	0	1	1	0	2	5	2	16	27			~		
	CY8C4024LQI-S413	24	16	2	0	1	1	0	2	5	2	16	34				~	
	CY8C4024AZI-S413	24	16	2	0	1	1	0	2	5	2	16	36					~
	CY8C4025FNI-S402	24	32	4	0	0	1	0	2	5	2	8	21	~				
	CY8C4025LQI-S401	24	32	4	0	0	1	0	2	5	2	8	19		~			
	CY8C4025LQI-S402	24	32	4	0	0	1	0	2	5	2	16	27			~		
4025	CY8C4025AZI-S403	24	32	4	0	0	1	0	2	5	2	16	36					~
4025	CY8C4025FNI-S412	24	32	4	0	1	1	0	2	5	2	8	21	~				
	CY8C4025LQI-S411	24	32	4	0	1	1	0	2	5	2	8	19		~			
	CY8C4025LQI-S412	24	32	4	0	1	1	0	2	5	2	16	27			~		
	CY8C4025AZI-S413	24	32	4	0	1	1	0	2	5	2	16	36					~
	CY8C4045FNI-S412	48	32	4	0	1	1	0	2	5	2	8	21	~				
4045	CY8C4045LQI-S411	48	32	4	0	1	1	0	2	5	2	8	19		~			
4040	CY8C4045LQI-S412	48	32	4	0	1	1	0	2	5	2	16	27			~		
	CY8C4045AZI-S413	48	32	4	0	1	1	0	2	5	2	16	36					~

The nomenclature used in the preceding table is based on the following part numbering convention:

Field	Description	Values	Meaning
CY8C	Cypress Prefix		
4	Architecture	4	PSoC 4
А	Family	0	4000 Family
в	CPU Speed	2	24 MHz
		4	48 MHz



Packaging

The PSoC 4000S will be offered in 48-pin TQFP, 40-pin QFN, 32-pin QFN, 24-pin QFN, and 25-ball WLCSP packages. Package dimensions and Cypress drawing numbers are in the following table.

Table 36. Package List

Spec ID#	Package	Description	Package Dwg
BID20	48-pin TQFP	$7 \times 7 \times 1.4$ mm height with 0.5-mm pitch	51-85135
BID27	40-pin QFN	6 × 6 × 0.6 mm height with 0.5-mm pitch	001-80659
BID34A	32-pin QFN	$5 \times 5 \times 0.6$ mm height with 0.5-mm pitch	001-42168
BID34	24-pin QFN	$4 \times 4 \times 0.6$ mm height with 0.5-mm pitch	001-13937
BID34F	25-ball WLCSP	2.02 × 1.93 × 0.48 mm height with 0.35-mm pitch	002-09957

Table 37. Package Thermal Characteristics

Parameter	Description	Package	Min	Тур	Max	Units
Та	Operating ambient temperature		-40	25	85	°C
TJ	Operating junction temperature		-40	-	100	°C
Tja	Package θ _{JA}	48-pin TQFP	-	73.5	-	°C/Watt
TJC	Package θ_{JC}	48-pin TQFP	-	33.5	-	°C/Watt
Tja	Package θ _{JA}	40-pin QFN	-	17.8	-	°C/Watt
TJC	Package θ_{JC}	40-pin QFN	-	2.8	-	°C/Watt
Tja	Package θ _{JA}	32-pin QFN	-	20.8	-	°C/Watt
TJC	Package θ_{JC}	32-pin QFN	-	5.9	-	°C/Watt
Tja	Package θ_{JA}	24-pin QFN	-	21.7	-	°C/Watt
TJC	Package θ_{JC}	24-pin QFN	-	5.6	-	°C/Watt
Tja	Package θ_{JA}	25-ball WLCSP	-	54.6	-	°C/Watt
TJC	Package θ_{JC}	25-ball WLCSP	-	0.5	-	°C/Watt

Table 38. Solder Reflow Peak Temperature

Package Maximum Peak Temperature			Maximum Time at Peak Temperature	
	All	260 °C	30 seconds	

Table 39. Package Moisture Sensitivity Level (MSL), IPC/JEDEC J-STD-020

Package	MSL
All except WLCSP	MSL 3
25-ball WLCSP	MSL 1



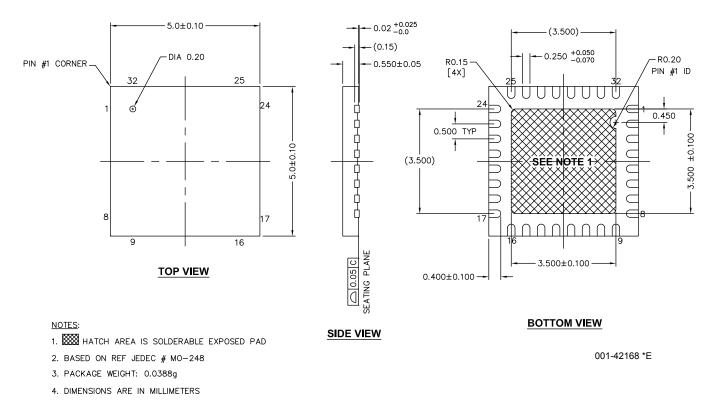
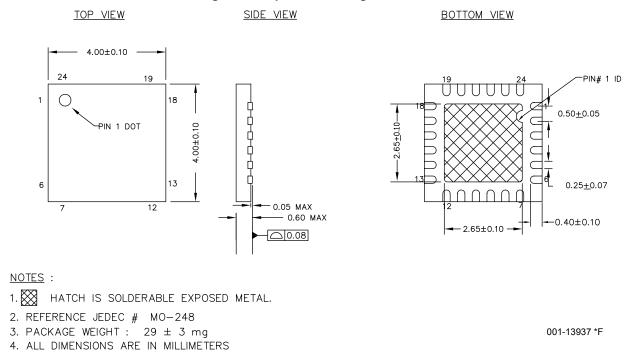


Figure 7. 32-pin QFN Package Outline

Figure 8. 24-pin QFN Package Outline



The center pad on the QFN package should be connected to ground (VSS) for best mechanical, thermal, and electrical performance. If not connected to ground, it should be electrically floating and not connected to any other signal.



Acronyms

Table 40. Acronyms Used in this Document

Acronym	Description
abus	analog local bus
ADC	analog-to-digital converter
AG	analog global
АНВ	AMBA (advanced microcontroller bus architecture) high-performance bus, an ARM data transfer bus
ALU	arithmetic logic unit
AMUXBUS	analog multiplexer bus
API	application programming interface
APSR	application program status register
ARM®	advanced RISC machine, a CPU architecture
ATM	automatic thump mode
BW	bandwidth
CAN	Controller Area Network, a communications protocol
CMRR	common-mode rejection ratio
CPU	central processing unit
CRC	cyclic redundancy check, an error-checking protocol
DAC	digital-to-analog converter, see also IDAC, VDAC
DFB	digital filter block
DIO	digital input/output, GPIO with only digital capabilities, no analog. See GPIO.
DMIPS	Dhrystone million instructions per second
DMA	direct memory access, see also TD
DNL	differential nonlinearity, see also INL
DNU	do not use
DR	port write data registers
DSI	digital system interconnect
DWT	data watchpoint and trace
ECC	error correcting code
ECO	external crystal oscillator
EEPROM	electrically erasable programmable read-only memory
EMI	electromagnetic interference
EMIF	external memory interface
EOC	end of conversion
EOF	end of frame
EPSR	execution program status register
ESD	electrostatic discharge

Table 40. Acronyms Used in this Document (continued)

Acronym	Description	
ETM	embedded trace macrocell	
FIR	finite impulse response, see also IIR	
FPB	flash patch and breakpoint	
FS	full-speed	
GPIO	general-purpose input/output, applies to a PSoC pin	
HVI	high-voltage interrupt, see also LVI, LVD	
IC	integrated circuit	
IDAC	current DAC, see also DAC, VDAC	
IDE	integrated development environment	
I ² C, or IIC	Inter-Integrated Circuit, a communications protocol	
lir	infinite impulse response, see also FIR	
ILO	internal low-speed oscillator, see also IMO	
IMO	internal main oscillator, see also ILO	
INL	integral nonlinearity, see also DNL	
I/O	input/output, see also GPIO, DIO, SIO, USBIO	
IPOR	initial power-on reset	
IPSR	interrupt program status register	
IRQ	interrupt request	
ITM	instrumentation trace macrocell	
LCD	liquid crystal display	
LIN	Local Interconnect Network, a communications protocol.	
LR	link register	
LUT	lookup table	
LVD	low-voltage detect, see also LVI	
LVI	low-voltage interrupt, see also HVI	
LVTTL	low-voltage transistor-transistor logic	
MAC	multiply-accumulate	
MCU	microcontroller unit	
MISO	master-in slave-out	
NC	no connect	
NMI	nonmaskable interrupt	
NRZ	non-return-to-zero	
NVIC	nested vectored interrupt controller	
NVL	nonvolatile latch, see also WOL	
opamp	operational amplifier	
PAL	programmable array logic, see also PLD	



Acronym	Description	
PC	program counter	
PCB	printed circuit board	
PGA	programmable gain amplifier	
PHUB	peripheral hub	
PHY	physical layer	
PICU	port interrupt control unit	
PLA	programmable logic array	
PLD	programmable logic device, see also PAL	
PLL	phase-locked loop	
PMDD	package material declaration data sheet	
POR	power-on reset	
PRES	precise power-on reset	
PRS	pseudo random sequence	
PS	port read data register	
PSoC [®]	Programmable System-on-Chip™	
PSRR	power supply rejection ratio	
PWM	pulse-width modulator	
RAM	random-access memory	
RISC	reduced-instruction-set computing	
RMS	root-mean-square	
RTC	real-time clock	
RTL	register transfer language	
RTR	remote transmission request	
RX	receive	
SAR	successive approximation register	
SC/CT	switched capacitor/continuous time	
SCL	I ² C serial clock	
SDA	I ² C serial data	
S/H	sample and hold	
SINAD	signal to noise and distortion ratio	
SIO	special input/output, GPIO with advanced features. See GPIO.	
SOC	start of conversion	
SOF	start of frame	
SPI	Serial Peripheral Interface, a communications protocol	
SR	slew rate	
SRAM	static random access memory	
SRES	software reset	
SWD	serial wire debug, a test protocol	

Table 40. Acronyms Used in this Document (continued)

Acronym Description SWV single-wire viewer TD transaction descriptor, see also DMA THD total harmonic distortion TIA transimpedance amplifier TRM technical reference manual TTL transistor-transistor logic ΤХ transmit UART Universal Asynchronous Transmitter Receiver, a communications protocol UDB universal digital block USB Universal Serial Bus USBIO USB input/output, PSoC pins used to connect to a USB port VDAC voltage DAC, see also DAC, IDAC WDT watchdog timer WOL write once latch, see also NVL WRES watchdog timer reset XRES external reset I/O pin XTAL crystal

Table 40. Acronyms Used in this Document (continued)



Revision History

Description Title: PSoC [®] 4: PSoC 4000S Family Datasheet Programmable System-on-Chip (PSoC) Document Number: 002-00123				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	4883809	WKA	08/28/2015	New datasheet
*A	4992376	WKA	10/30/2015	Updated Pinouts. Added $V_{DDD} \ge 2.2V$ at -40 °C under Conditions for specs SID247A, SID90, SID92. Updated Table 12. Updated Ordering Information.
*B	5037826	SLAN	12/08/2015	Changed datasheet status to Preliminary
*C	5104369	WKA	01/27/2016	Added Errata. Added 25 WLCSP package details. Updated theta J_A and J_C values for all packages.
*D	5139206	WKA	02/16/2016	Updated copyright information at the end of the document.
*E	5173961	WKA	03/15/2016	Updated Pinouts. Updated values for SID79, BID194. SID175, and SID176. Updated CSD and IDAC Specifications. Updated 10-bit CapSense ADC Specifications.
*F	5268662	WKA	05/12/2016	Updated Alternate Pin Functions. Updated the following specs: SID310, SID312, SID313, SID314, SID314C, SID314D, SID314E, SID315, SID315C, SID315D, SID315E, SID322A, SID322B, SIDA109. Removed Errata section. Updated the Cypress logo and copyright information based on the template.
*G	5330930	WKA	07/27/2016	Updated LCD Segment Drive. Updated SID60 conditions. Updated IDD specs. Corrected package dimensions for WLCSP package and added WLCSP MSL condition. Moved datasheet status to Final.
*H	5415365	WKA	09/14/2016	Added 40-pin QFN pin and package details. Updated IDD spec values in DC Specifications.
*	5561833	WKA	01/09/2017	Changed PRGIO references to Smart I/O.
*J	5704046	GNKK	04/26/2017	Updated the Cypress logo and copyright information.



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